

TCD3  
3.2 x 5.0 x 1.50 mm  
LCC Ceramic Package

## Features

- Pletronics' TCD3 Stratum-III Type Series Temperature Compensated Crystal Oscillator
- Optional Voltage Control Function
- Low Power / Fast Warm Up
- Clipped Sine Wave Output
- 2.8V to 3.3V nominal Supply Voltage
- See table for developed Frequencies

## Applications

SONET / SDH / DWDM  
Test & Measurement  
Telecom Transmission & Switching Equipment  
Base Stations / Picocell  
Wireless Communication Equipment

## Electrical Characteristics

Parameter	Min	Typ	Max	Unit	Condition (Consult factory for other options)
Frequency Range <sup>2</sup>	8.192	-	40.0	MHz	See table below for developed frequencies
Frequency Stability vs. Temperature <sup>2</sup>	-	±0.28	-	ppm	$(f_{max} - f_{min}) / 2$
Frequency Initial Calibration	-	-	±1.0	ppm	25°C ± 2°C, 24 hours after reflow
Operating Temperature Range <sup>2</sup>	-40	-	+85	°C	Widest range available
Supply Voltage <sup>1,2</sup> V <sub>CC</sub>	2.8	-	3.3	Volts	± 5%
Supply Current I <sub>CC</sub>	-	-	7.0	mA	Load: 10 Kohm    10 pF, V <sub>CC</sub> ± 5%
24 Hour Holdover	-	-	±0.37	ppm	
Frequency Stability vs. Supply	-	-	±0.2	ppm	Load: 10 Kohm    10 pF, V <sub>CC</sub> ± 5%
Frequency Stability vs. Load	-	-	±0.2	ppm	Load: 10 Kohm    10 pF ± 5%
Vcontrol Range	0.5	-	2.5	Volts	1.50 volts nominal for V <sub>CC</sub>
Frequency Pullability <sup>2</sup>	0	±8.0	±12.0	ppm	Positive Slope
Linearity	-	-	2.0	%	
Output Waveform	Clipped Sine Wave				DC Coupled
Output Level	0.8	-	-	V p-p	Load: 10 Kohm    10 pF ± 10%
Startup Time	-	-	3.0	S	Time to reach specified frequency
Long term stability (Aging)	-	±3.0	-	ppm	After 15 years
Jitter	-	0.6	-	pS	Frequency offset from carrier 12 kHz to 5 MHz, typical performance at 20.0 MHz
Phase Noise	10 Hz 100 Hz 1 kHz 10 kHz	-	-100 -120 -134 -144	-	dBc/Hz 25°C ± 2°C at 26.0 MHz
Storage Temperature Range	-55	-	+95	°C	

Note: <sup>1</sup> Place a 10nF power supply bypass capacitor next to device for correct operation

<sup>2</sup> Specified by part number.

**The following is a list of developed frequencies. Consult factory for other options.**

8.192M, 9.60M, 9.72M, 10.00M, 12.80M, 13.00M, 16.384M,  
19.20M, 19.44M, 20.00M, 25.60M, 26.00M, 40.00M only

### Part Number (Possible Options shown)

Series Model	V <sub>CC</sub> Supply Voltage <sup>1</sup>		Operating Temperature		Stability <sup>1,2</sup>	Pullability <sup>1</sup>	Frequency
	Lowest	Highest	Lowest	Highest	(ppm)	(ppm)	(MHz)
TCD3	<b>031</b>	<b>035</b>	<b>L</b>	<b>K</b>	<b>280</b>	<b>008</b>	<b>-19.20M</b>
	<b>031</b> = 3.1 for 3.3 volts nominal <b>029</b> = 2.9 for 3.0 volts nominal <b>027</b> = 2.7 for 2.8 volts nominal	<b>035</b> = 3.5 for 3.3 volts nominal <b>031</b> = 3.1 for 3.0 volts nominal <b>029</b> = 2.9 for 2.8 volts nominal	<b>A</b> = +10°C <b>B</b> = +5°C <b>C</b> = +0°C <b>D</b> = -5°C <b>E</b> = -10°C <b>F</b> = -15°C <b>G</b> = -20°C <b>H</b> = -25°C <b>J</b> = -30°C <b>K</b> = -35°C <b>L</b> = -40°C	<b>A</b> = +40°C <b>B</b> = +45°C <b>C</b> = +50°C <b>D</b> = +55°C <b>E</b> = +60°C <b>F</b> = +65°C <b>G</b> = +70°C <b>H</b> = +75°C <b>J</b> = +80°C <b>K</b> = +85°C	<b>280</b> = ± 0.28 <b>500</b> = ± 0.5	<b>000</b> = TCXO <b>005</b> = ± 5 <b>008</b> = ± 8	10 - 40 MHz  <b>Developed:</b> 8.192M, 9.60M, 9.72M, 10.00M, 12.80M, 13.00M, 16.384M, 19.20M, 19.44M, 20.00M, 25.60M, 26.00M, 40.00M

<sup>1</sup> Contact Factory for non-standard specifications

<sup>2</sup> Not all stabilities are available with all operating temperature ranges. Contact Factory for exact combinations available.

### Device Marking

YMD  
FFFF.zzz  
YMD  
• PLEzzzzz  
YMD

OR

FFFF.zzz  
• P zzzzzz  
YMD

FFFF = Crystal Frequency in MHz (See Note Below)

zzz = Internal factory codes

P or PLE = Pletronics

YMD = Date code (may appear in any one of the locations shown)

**Note: Output Frequency may be half the Crystal Frequency marking, depending on requirements.**

Specifications such as part number, frequency stability, supply voltage and operating temperature range, etc. are not identified from marking. External packaging labels and packing list will correctly identify the ordered Pletronics part number.

Codes for Date Code YMD (Year Month Day)

Code	4	5	6	7	8	Code	A	B	C	D	E	F	G	H	J	K	L	M
Year	2014	2015	2016	2017	2018	Month	JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC

Code	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F	G	H	J	K	L	M	N	P	R	T	U	V	W	X	Y	Z
Day	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31

### Package Labeling

Tape and Reel available for quantities of 250 to 1000 per reel, cut tape for < 250. 16mm tape, 8mm pitch.

P/N Label is 1" x 2.6" (25.4mm x 66.7mm)  
 Font is Courier New  
 Bar code is 39-Full ASCII

RoHS Label is 1" x 2.6" (25.4mm x 66.7mm)  
 Font is Arial

P/N:   
 TCD3027036LK280008-20.0M  
 Customer P/N:   
 12345678  
 Qty:  1000      D/C:  103-M8ZU4  
 MSL: 1

RoHS Compliant  
 2nd Lvl Interconnect  
 Category=e4  
 Max Safe Temp=260C for 10s 2X Max

**Pletronics Inc. certifies this device is in accordance with the RoHS 2 (2011/65/EU) and WEEE (2002/96/EC) directives.**

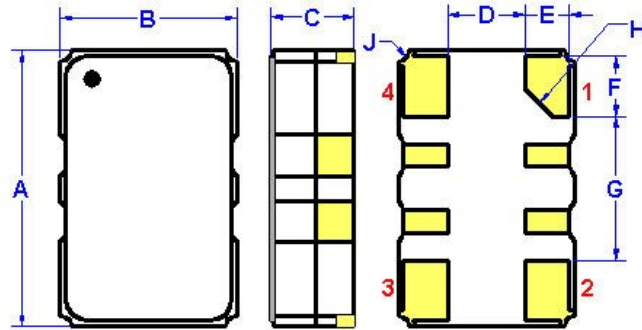
Pletronics Inc. guarantees the device does not contain the following: Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's  
 Weight of the Device: 0.10 grams

Moisture Sensitivity Level: 1 As defined in J-STD-020D

Second Level Interconnect code: e4

## Mechanical Dimensions

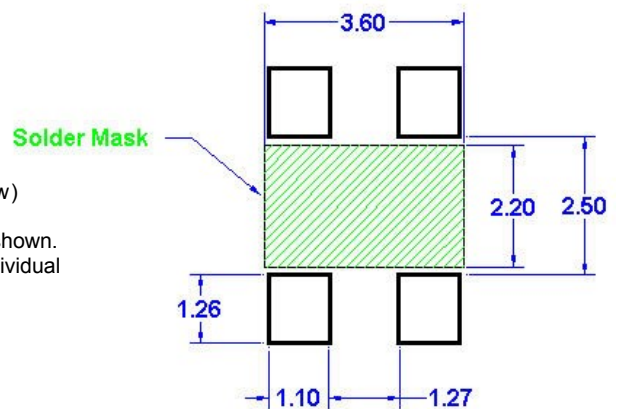
	Inches	mm
A	0.197 ± 0.008	5.00 ± 0.20
B	0.126 ± 0.008	3.20 ± 0.20
C	0.059 max	1.50 max
D <sup>1</sup>	0.055	1.40
E <sup>1</sup>	0.031	0.80
F <sup>1</sup>	0.043	1.10
G <sup>1</sup>	0.102	2.60
H <sup>1</sup>	0.020C	0.50C
J <sup>1</sup>	0.008R	0.20R



<sup>1</sup> Typical dimensions

### Pad Layout mm shown (Top View)

Disclaimer: Recommended layout shown.  
Adjust pad layout as needed for individual  
process requirements.  
Solder mask required, as shown.



(Not to Scale)

**Contacts (pads):** Gold 11.8 to 39.4 μmches (0.3 to 1.0 μm) over Nickel 50 to 350 μmches (1.27 to 8.89 μm)

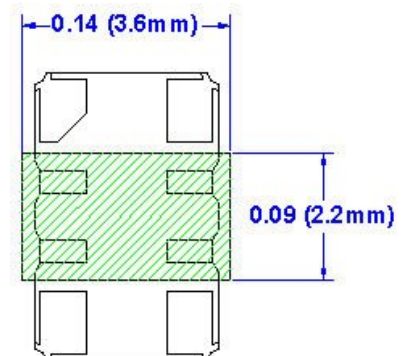
## Layout

Pad	Function	Note
1	Vcontrol Input	If this function is not specified, recommend connecting this pad to ground. EFC (Electronic Frequency Control).
2	Ground (GND)	
3	Output	The output is DC coupled. Most commonly used with external coupling capacitor. 0.001 to 0.01μF recommended
4	V <sub>CC</sub> Supply Voltage	Connect an appropriate 10nF power supply bypass capacitor as close as possible
5	N.C.	All other pads on the bottom shall not be connected. These are internally connected for the TCXO compensation process

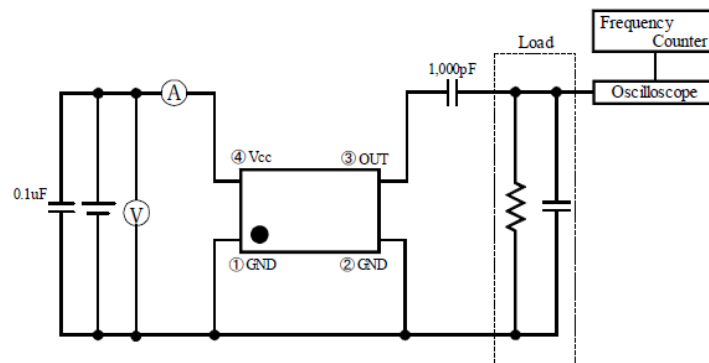
All connection points in the designated region have solder mask cover to avoid any electrical connections (top view shown)

For Optimum Jitter Performance, Pletronics recommends:

- A ground plane under the device
- Do not route large transient signals (both current and voltage) under the device
- Do not place near a large magnetic field such as a high frequency switching power supply
- Do not place near piezoelectric buzzers or mechanical fans
- Minimize air flow across the device



## Electrical Test /Load Circuit



## Environmental / ESD Ratings

Reliability: Environmental Compliance

ESD Rating

Parameter	Condition
Mechanical Shock	JESD22-B104
Vibration	JESD22-B103
Solderability	IPC J-STD-002
Thermal Shock	MIL-STD-883 Method 1011, Condition A

Model	Min. Voltage	Condition
Human Body Model	2000V	JESD22-A114
Charged Device Model	500V	JESD 22-C101
Machine Model	200V	JESD22-A115

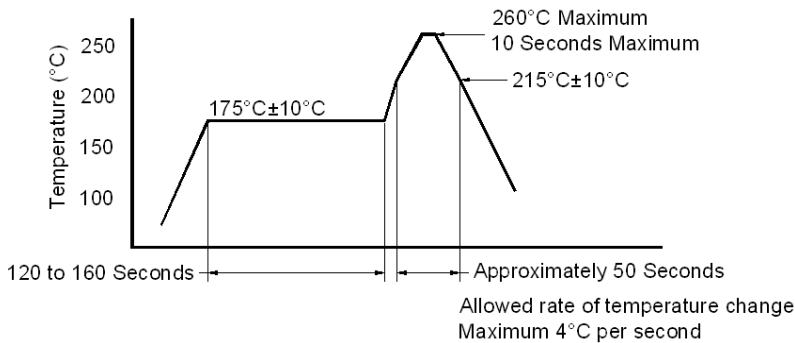
Absolute Maximum Ratings

Parameter	Unit
V <sub>CC</sub> Supply Voltage	-0.6V to +6V
V <sub>i</sub> Input Voltage	-0.6V to V <sub>CC</sub> + 0.6V
I <sub>o</sub> Output Current	-10mA to +10mA

### Thermal Characteristics:

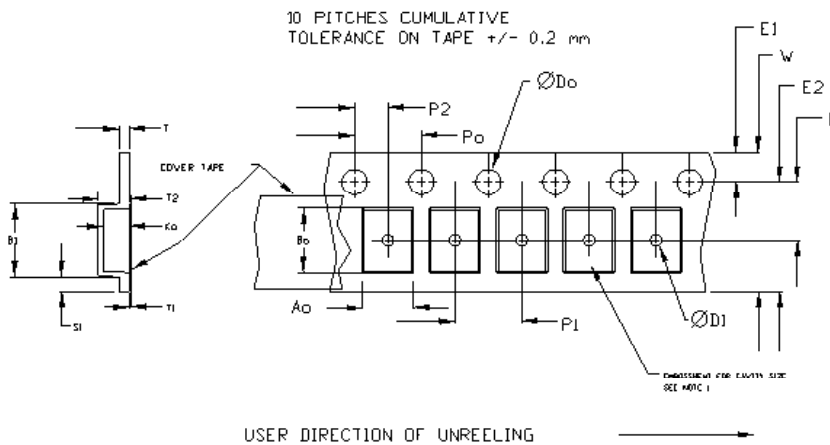
The maximum die or junction temperature is 155°C  
The thermal resistance junction to board is 30 to 50°C/Watt depending on the solder pads, ground plane and construction of the PCB.

## Reflow Cycle



The part may be reflowed 2 times without degradation (typical for lead free processing).

## Tape and Reel

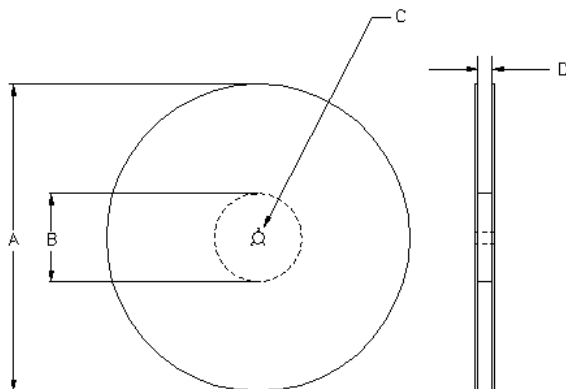


Tape Size	Do	D1 min	E1	Po	P2	S1 min	T max	T1 max
8mm	1.5	1.0	1.75	4.0	±0.05	0.6	0.6	0.1
12mm		1.5						
16mm		1.5						
24mm	+0.1 -0.0	1.5	±0.1	±0.1	±0.1			

Tape Size	B1 max	E2 min	F	P1	T2 max	W max	Ao, Bo & Ko
16mm	12.1	14.25	7.5 ±0.1	8.0 ±0.1	8.0	16.3	Note 1

Dimensions in mm Drawing Not to scale

Note 1: Embossed cavity to conform to EIA-481-B



Reel Size	A		B		C	D
	Inches	mm	Inches	mm	mm	mm
7	7.0	177.8	2.50	63.5	13.0 +0.5 -0.2	Tape size +0.4 +2.0 -0.0
10	10.0	254.0	4.00	101.6		
13	13.0	330.2	3.75	95.3		

### Important Notice

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